

MICROPROCESSOR OVERCURRENT and EARTH FAULT RELAY

TYPE

MC11

OPERATION MANUAL



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Doc. N° MO-0323-ING



1. GENERAL UTILIZATION AND COMMISSIONING DIRECTIONS

Always make reference to the specific description of the product and to the Manufacturer's instruction. Carefully observe the following warnings.

1.1 - Storage and Transportation

must comply with the environmental conditions stated on the product's instruction or by the applicable IEC standards.

1.2 - Installation

must be properly made and in compliance with the operational ambient conditions stated by the Manufacturer.

1.3 - Electrical Connection

must be made strictly according to the wiring diagram supplied with the Product, to its electrical characteristics and in compliance with the applicable standards particularly with reference to human safety.

1.4 - Measuring Inputs and Power Supply

carefully check that the value of input quantities and power supply voltage are proper and within the permissible variation limits.

1.5 - Outputs Loading

must be compatible with their declared performance.

1.6 - Protection Earthing

When earthing is required, carefully check its effectiveness.

1.7 - Setting and Calibration

Carefully check the proper setting of the different functions according to the configuration of the protected system, the safety regulations and the co-ordination with other equipment.

1.8 - Safety Protection

Carefully check that all safety means are correctly mounted, apply proper seals where required and periodically check their integrity.

1.9 - Handling

Notwithstanding the highest practicable protection means used in designing M.S. electronic circuits, the electronic components and semiconductor devices mounted on the modules can be seriously damaged by electrostatic voltage discharge which can be experienced when handling the modules. The damage caused by electrostatic discharge may not be immediately apparent but the design

The damage caused by electrostatic discharge may not be immediately apparent but the design reliability and the long life of the product will have been reduced. The electronic circuits reduced by M.S. are completely safe from electrostatic discharge (8 KV IEC 255.22.2) when housed in their case; withdrawing the modules without proper cautions expose them to the risk of damage.



- a. Before removing a module, ensure that you are at the same electrostatic potential as the equipment by touching the case.
- b. Handle the module by its front-plate, frame, or edges of the printed circuit board. Avoid touching the electronic components, printed circuit tracks or connectors.
- c. Do not pass the module to any person without first ensuring that you are both at the same electrostatic potential. Shaking hands achieves equipotential.
- d. Place the module on an antistatic surface, or on a conducting surface which is at the same potential as yourself.
- e. Store or transport the module in a conductive bag.

More information on safe working procedures for all electronic equipment can be found in BS5783 and IEC 147-OF.

1.10 - Maintenance

Make reference to the instruction manual of the Manufacturer; maintenance must be carried-out by specially trained people and in strict conformity with the safety regulations.

1.11 - Waste Disposal of Electrical & Electronic Equipment

(Applicable throughout the European Union and other European countries with separate collection program).

This product should not be treated as household waste when you wish dispose of it. Instead, it should be handed over to an applicable collection point for the recycling of electrical and electronic equipment. By ensuring this product is disposed of correctly, you will help prevent potential negative consequence to the environment and human health, which could otherwise be caused by inappropriate disposal of this product. The recycling of materials will help to conserve natural resource.

1.12 - Fault detection and repair

Internal calibrations and components should not be altered or replaced. For repair please ask the Manufacturer or its authorised Dealers.

Misapplication of the above warnings and instruction relieves the Manufacturer of any liability.

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2. GENERAL CHARACTERISTICS

The MC is a very innovative and versatile line of Protective Relays which takes advantage of the long and successful experience coming from the M-Line.

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The main features of the MC-Line relays are:

Compact draw-out execution for Flush Mounting or for assembly in 19" 3U chassis for 19" Rack systems.

User friendly front face with 2x8 characters LCD Display, four signal Leds, four keys for complete local management and 9-pin socket for local RS232 serial communication.

Four user programmable Output Relays. On request one of the Output Relays can be replaced by a Can Bus port for control of additional I/O modules.

Three optoisolated, self-powered Digital Inputs.

RS485 communication port (independent from the RS232 port on front panel)

Totally draw-out execution with automatic C.T. shorting device.

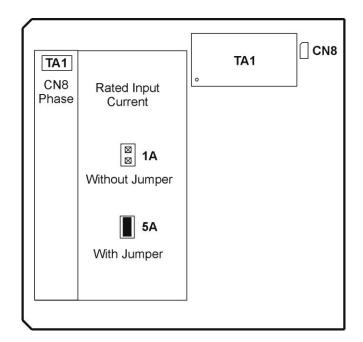
Input current is supplied to 1 current transformer: - measuring the current Input voltage is supplied to 1 voltage transformer: - measuring the voltage Current input can be 1 or 5A, selection between 1A or 5A is made by movable jumpers provided on the Relay card. (see Fig 1)

The Measuring Ranges of the different inputs respectively are:

Phase Currents : (0.1-40)In

Make electric connection in conformity with the diagram reported on relay's enclosure.

Check that input currents are same as reported on the diagram and on the test certificate.



2.1 - Power Supply

The auxiliary power is supplied by a built-in module fully isolated an self protected.

Two options are available:

Before energising the unit check that supply voltage is within the allowed limits.



2.2 - Operation and Algorithms

2.2.1 - Reference Input Values

Display			Description	Settin	ng R	Range	Step	Unit
11	1000	Α	Rated Primary current of phase C.T.	1	-	9999	1	Α
12	1	Α	Rated Secondary current of phase C.T.	1	-	5	1/5	Α
In	1000	Α	Reference primary current of the relay	1	-	9999	1	Α
V1	25	kV	Rated Primary voltage of phase V.T.	0.05	-	500	0.01	kV
V2	100	V	Rated Secondary voltage of phase V.T.	50	-	115	0.01	V
Freq	60	Hz	System rated frequency	50	-	60	10	Hz
TW	30	min	Warming-up time constant for Thermal Image	1	-	60	1	min.
lb	105	%ln	Maximum admissible continuous overload for Thermal Image	50	-	130	1	%ln

2.2.2 - Input quantities

2.2.2.1 - Mains Frequency (Freq)

The relay can operate either in 50Hz or 60Hz systems.

The rated Mains Frequency "Freq "must be set accordingly.

2.2.2.2 – Line Current Input (I1)

The relay directly displays the r.m.s. value of the Line Currents " I ", flowing in the Primary of the input Current Transformers and refers all its measurements to that value.

To make the relay properly working with any C.T., when programming the relay settings, input the value "I1" of the primary current of the phase C.Ts

2.2.2.3 – Line Voltage Input (V1)

The relay directly displays the r.m.s. value of the Line Voltage " **V** ", applied on the Primary of the input Voltage Transformers and refers all its measurements to that value.

To make the relay properly working with any V.T., when programming the relay settings, input the value "V1" of the primary current of the phase V.Ts

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2.2.3 - Functions and Settings (Function)

2.2.3.1 - T> (F49) - Thermal Image protection level

FuncEnab	\rightarrow	Disable]	[Disable / Enable]			
Options		No Param		No Parameters			
TripLev	→ Tal	63.00	%Tb	(50.00 ÷ 110.00)	step	1	%Tb
	→ Tst	50.00	%Tb	$(10.00 \div 100.00)$	step	1	%Tb
Timers	\rightarrow	No Param]	No Parameters			

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FuncEnab : If disable the function is disactivated.

□ Tal : Thermal prealarm temperature.

□ Tst : Reset level.

Warming-up is computed proportionally to the square of the largest phase current "I".

- Allowed overloading time (See Curve)

The trip time delay " **t** " of the thermal element, depends on the warming-up time constant " **tw** ", on the previous thermal status (Ip/In)², on the admissible continuous overload (Ib) and, of course, on the actual load (I)

$$t = tw \cdot \ell_n \left[\frac{(V \ln)^2 - (lp/\ln)^2}{(V \ln)^2 - (lb/\ln)^2} \right]$$
 where:

tw = Warming-up time constant (1-60)min.

l = Line current

Ip = Preheating current: Steady-State Current corresponding to the thermal status existing at the moment when the current is increased to the overload value "I"

Ib = Continuously admissible current (50-130)%In, step 1%In

In = Rated primary current of phase C.Ts

 ℓ **n** = Natural logarithm

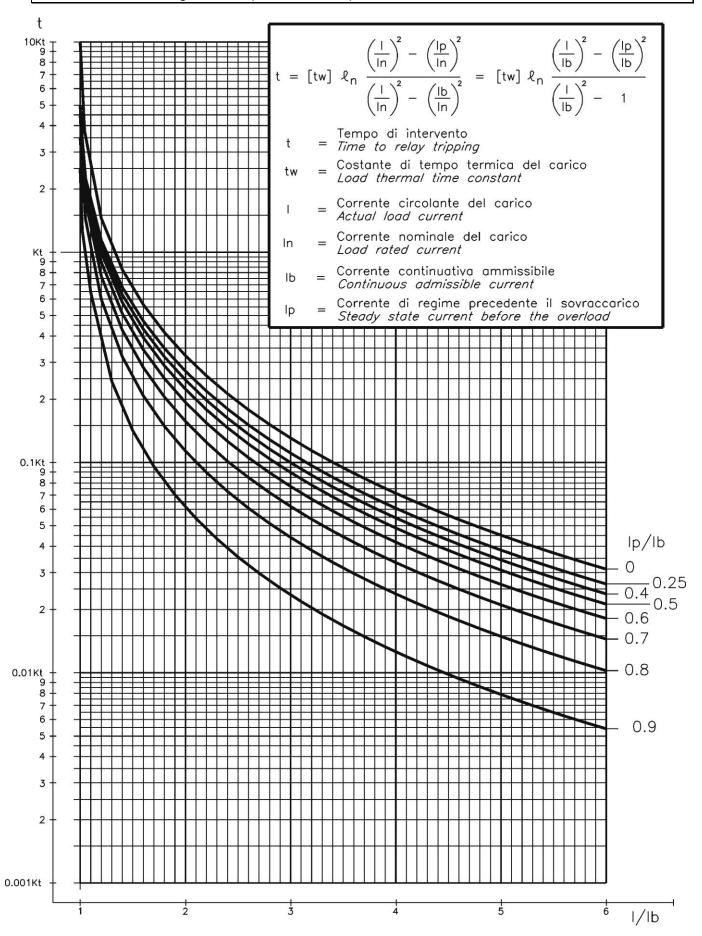
Reset takes please when the simulated temperature drops below the programming level [Tst].

An alarm signal is issued when the computed warming exceeds the set percentage "Tal" of the Full Load temperature "Tb".

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2.2.3.2 - Thermal Image Curves (TU1091 Rev.1)



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2.2.3.3 - I> (1F51) - First overcurrent protection level

FuncEnab	\rightarrow		Enable		[Disable / Enable]			
Options	$\begin{array}{c} \rightarrow \\ \rightarrow \end{array}$	BI Trg	Disable Disable		[Disable / Enable] [Disable / Enable]			
TripLev	\rightarrow	<i>l</i> >	1.2	In	$(0.50 \div 20.00)$	step	0.01	In
Timers	\rightarrow	tl>	1.00	s	$(0.05 \div 60.00)$	step	0.01	s

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□ FuncEnab : If disable the function is disactivated
□ BI : Operation controlled by Blocking Digital Input
□ Trg : Function operation triggers the oscillographic wave form capture (see § Oscillographic)
□ I> : Minimum phase current pick-up level (limited to 40 times In)
□ tl> : Trip time delay

2.2.3.4 - I>> (2F51) - Second overcurrent protection level

FuncEnab	\rightarrow		Enable		[Disable / Enable]			
Options	$\begin{array}{c} \rightarrow \\ \rightarrow \end{array}$	BI Trg	Disable Disable		[Disable / Enable] [Disable / Enable]			
TripLev	\rightarrow	<i>l>></i>	1.50	In	$(0.50 \div 40.00)$	step	0.01	In
Timers	\rightarrow	<i>tl>></i>	0.05	s	$(0.05 \div 60.00)$	step	0.01	s

□ FuncEnab : If disable the function is disactivated
□ BI : Operation controlled by Blocking Digital Input
□ Trg : Function operation triggers the oscillographic wave form capture (see § Oscillographic)
□ I>> : Minimum phase current pick-up level (limited to 40 times In)
□ tl>> : Trip time delay

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2.2.3.5 - V> (1F59) - First overvoltage protection level (smallest of 3 phase-to-neutral voltages)

FuncEnab	\rightarrow		Enable		[Disable / Enable]			
Options	$\begin{array}{c} \rightarrow \\ \rightarrow \\ \rightarrow \end{array}$	BI Trg	Disable Disable		[Disable / Enable] [Disable / Enable]			
TripLev	\rightarrow	V>	1.20	Vn	(0.50 ÷ 1.50)	step	0.01	Vn
Timers	\rightarrow	tV>	1.00	s	$(0.05 \div 60.00)$	step	0.01	S

□ FuncEnab : If disable the function is disactivated

BI : Operation controlled by Blocking Digital Input

□ Trg : Function operation triggers the oscillographic wave form capture

(see § Oscillographic)

□ V> : Trip level of overvoltage protection

□ tV> : Trip time delay

2.2.3.6 - V>> (2F59) - Second overvoltage protection level (largest of 3 phase-to-neutral voltages)

FuncEnab	\rightarrow	Enable		[Disable / Enable]			
Options	$\begin{array}{c} \rightarrow & BI \\ \rightarrow & Trg \end{array}$	Disable Disable		[Disable / Enable] [Disable / Enable]			
TripLev	→ V>>	1.50	Vn	$(0.50 \div 1.50)$	step	0.01	Vn
Timers	→ <i>t</i> V>>	0.05	s	$(0.05 \div 60.00)$	step	0.01	s

□ FuncEnab : If disable the function is disactivated

BI : Operation controlled by Blocking Digital Input

□ Trg : Function operation triggers the oscillographic wave form capture

(see § Oscillographic)

□ V>> : Trip level of overvoltage protection

□ tV>> : Trip time delay



2.2.3.7 - V< (1F27) - First undervoltage protection level (smallest of 3 phase-to-neutral voltages)

FuncEnab	\rightarrow		Disable		[Disable / Enable]			
Options	$\begin{array}{c} \rightarrow \\ \rightarrow \end{array}$	BI Trg	Disable Disable		[Disable / Enable] [Disable / Enable]			
TripLev	\rightarrow	V<	0.70	Vn	(0.20 ÷ 1.20)	step	0.01	Vn
Timers	\rightarrow	tV<	1.00	s	$(0.05 \div 60.00)$	step	0.01	S

□ FuncEnab : If disable the function is disactivated
□ BI : Operation controlled by Blocking Digital Input
□ Trg : Function operation triggers the oscillographic wave form capture (see § Oscillographic)
□ V< : Trip level of undervoltage protection
□ tV< : Trip time delay

2.2.3.8 - **V<< (2F27)** - Second undervoltage protection level (smallest of 3 phase-to-neutral voltages)

FuncEnab	\rightarrow		Disable		[Disable / Enable]			
Options	\rightarrow	BI	Disable		[Disable / Enable]			
	\rightarrow	Trg	Disable		[Disable / Enable]			
TripLev	\rightarrow	V<<	0.50	Vn	(0.20 ÷ 1.20)	step	0.01	Vn
Timers	\rightarrow	tV<<	0.05	s	$(0.05 \div 60.00)$	step	0.01	S

	FuncEnab	: If disable the function is disactivated
	BI	: Operation controlled by Blocking Digital Input
<u> </u>	Trg	: Function operation triggers the oscillographic wave form capture (see § Oscillographic)
	V<<	: Trip level of undervoltage protection
	tV<<	: Trip time delay

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2.2.3.9 - DI - Current step element

FuncEnab	\rightarrow	Enable		[Disable / Enable]		
Options	$ \begin{array}{c} \rightarrow & BI \\ \rightarrow & Trg \\ \rightarrow & Ncy \\ \rightarrow & BX \end{array} $	Disable Disable 1 Enable	су	[Disable / Enable] [Disable / Enable] (1 ÷ 4) [Disable / Enable]	step	1	су
TripLev	$ \begin{array}{c} \rightarrow DI \\ \rightarrow di \\ \rightarrow X \\ \rightarrow 2H \end{array} $	10 10 50 20	%In Ams ohm %In	(10 ÷ 99.99) (10 ÷ 320) (5 ÷ 50) (5 ÷ 20)	step step step step	1 1 1	%In A/ms(*) ohm %In
Timers	 → tdi → tDI 	0.05 0.10	s s	(0.05 ÷ 0.50) (0.00 ÷ 0.05)	step step	0.01 0.01	s s

^{* (}Primary Amps, accuracy is ±2 secondary Am/s)

□ FuncEnab : If disable the function is disactivated

□ BI : Operation controlled by Blocking Digital Input

□ Trg : Function operation triggers the oscillographic wave form capture

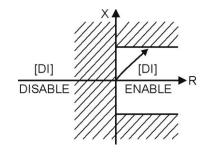
(see § Oscillographic)

Ncy
 Number of cycles for averaging di/dt detection
 Disable = Reactance blocking deactivated.

Enable = The element blocking the "DI" trip, when the reactive

component "X" of the fault impedance exceeds the setting

value. (first and second quadrant of complex plane)



DI	: Current step range
di	: Minimum di/dt level to start \(\Delta \) evaluation and detection reset level
X	: Reactance setting range ≤.
2H	: Second Harmonic Restraint (when the second harmonic exceed the setting
	blocking the trip is blocked)
tdi	: Detection reset time delay
tDI	: Evaluation time

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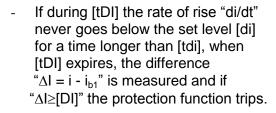
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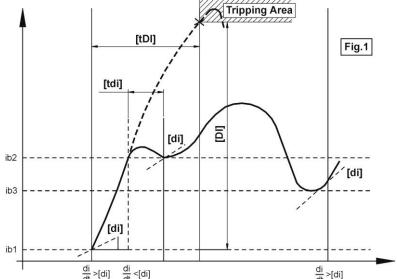
2.2.3.10 - Operation of the Current step monitoring element

The timely detection of a current step allow to clear a near short circuit long before the current can reach the prospective peak value.

<u>Protection Function Operation</u> (see Fig. 1):

- Any time a current rate of rise exceeding the set value [di] is detected the value of the current "i_{1b}" is recorded as reference basic value to evaluate the current step "ΔI = i i_{b1}" and the timer "tDI" is started.
 - "∆I" is evaluated every 1ms.





If during [tDI] the rate of rise "di/dt" goes below the set level [di] for a time longer than [tdi], a new value of the current i_{b2} is recorded and, when [tDI] expires. If the difference " $\Delta I = i - i_{b2}$ " measured is greater than [DI], the protection function trips.

In terms of equation the protection function operation is as follow:

$$\text{If } \frac{\text{di}}{\text{dt}} \! \geq \! \left[\text{di} \right] \! \Rightarrow \! \left\{ \! \! \begin{array}{l} \text{Value of Current } i_{\text{1b}} \text{ is } \text{ recorded} \\ \text{Timer tDI is Started} \end{array} \right\} \! \Rightarrow \! \text{If During tDI} \Rightarrow$$

$$\Rightarrow \begin{cases} \frac{di}{dt} \geq \left[di \right] duringt di \Rightarrow Trip \ if \ \Delta = i - i_{1b} \geq \left[DI \right] \ after \ tDI \\ \frac{di}{dt} < \left[di \right] duringt di \Rightarrow New \ Value \ of \ Current \ i_{2b} \ is \ recorded \Rightarrow Trip \ if \ \Delta = i - i_{2b} \geq \left[DI \right] after \ tDI \end{cases}$$

If, at the end of [tDI] no trip occurs " Δ I" evaluation is stopped and will restart when the set "di/dt" level is exceeded.



2.2.3.11 – **Z< (F21)** – Under Impedance element

FuncEnab	\rightarrow		Disable		[Disable / Enable]			
Options	$\begin{array}{c} \rightarrow \\ \rightarrow \end{array}$	BI Trg	Disable Disable		[Disable / Enable] [Disable / Enable]			
TripLev	\rightarrow	Z <	0.50	Zn	(0.10 ÷ 1.00)	step	0.01	Zn
Timers	\rightarrow	tZ<	0.15	s	(0.05 ± 60.00)	step	0.01	S

: If disable the function is disactivated Operation controlled by Blocking Digital Input : Function operation triggers the oscillographic wave form capture **Trg** (see § Oscillographic) Trip level of under-impedance protection

Trip time delay tZ<

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2.2.3.12 - RTD - Remote Trip

Remote trip is controlled via the Digital Input D2.

FuncEnab	\rightarrow	Disable	[Disable / Enable]
Options	\rightarrow	No Param	No Parameters
TripLev	\rightarrow	No Param	No Parameters
Timers	\rightarrow	No Param	No Parameters

□ FuncEnab : If disable the function is disactivated

2.2.3.13 - I.R.F. - Internal Relay Failure

FuncEnab	\rightarrow	No Param	No Parameters
Options	→ Opl	NoTrip	[NoTrip / Trip]
TripLev	\rightarrow	No Param	No Parameters
Timers	\rightarrow	No Param	No Parameters

: The variable "Opl " can be programmed to trip the output relays same as the other protection functions (Opl = TRIP), or to only operate the "IRF"

signal led without tripping the output relays (Opl = NoTRIP).



2.2.	2.2.3.14 - Osc - Oscillographic Recording								
Fun	cEnab	\rightarrow		Enable		[Disable / Enable]			
Opti	ions	\rightarrow	Trg	Trip		[Disable / Start / T	rip / Ext.Ir	np.]	
Trip	Lev	\rightarrow		No Param		No Parameters			
Tim	ers	$\stackrel{\rightarrow}{\rightarrow}$	tPre tPost	0.30 0.30	s s	(0.10 ÷ 0.50) (0.10 ÷ 1.50)	step step	0.1 0.1	s s
	FuncEnab	:	If disable	the function is di	sact	ivated			
	Trg	:	Disab = Function Disable (no recording) Start. = Trigger on time start of protection functions Trip = Trigger on trip (time delay end) of protection functions Ext.Inp. = Trigger from the Digital Input D3						
	tPre	:	Recording time before Trigger						
	tPost	:	Recordin	Recording time after Trigger					

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When the option "Start" or "Trip" is selected:

The oscillographic recording is started respectively by the "Time Start" or by the "Time End" of any of the functions that have been programmed to Trigger the Wave Form Capture.

The "Osc" Function includes the wave Form Capture of the input quantities (I, V) and can totally store a record of 3 seconds.

The number of events recorded depends on the duration of each individual recording (tPre + tPost). In any case the number of event stored can not exceed ten (10 x 0.3 sec).

Any new event beyond the 3 sec capacity of the memory, cancel and overwrites the former records (FIFO Memory).

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2.2.3.15 - Comm - Communication Parameters

FuncEnab	\rightarrow	No Param	No Parameters
Options	→ LBd	9600	[9600 / 19200 / 38400 / 57600]
•	→ RBd	19200	[9600 / 19200]
	→ Mod	8,e,1	[8,n,1 / 8,o,1 / 8,e,1]
	→ RPr	lec103	[lec103 / Modbus]
TripLev	\rightarrow	No Param	No Parameters
Timers	\rightarrow	No Param	No Parameters

□ **LBd** : Local Baud Rate (Front panel RS232 communication speed)

□ **RBd** : Remote Baud Rate

(Rear panel terminal blocks RS485 communication speed)

Mod : Remote mode (communication parameters)

Note: Any change of this setting becomes valid at the next power on

Remote Protocol (For IEC870-5.103 protocol set Rmd to 8,e,1)

2.2.3.16 - LCD - Display and Buzzer operation

FuncEnab	\rightarrow	No Param	No Parameters
Options	→ Key → BkL	BeepOFF Auto	[BeepOFF / BeepON] [Auto / On]
TripLev	\rightarrow	No Param	No Parameters
Timers	\rightarrow	No Param	No Parameters

Buzzer "Beep" on operation of Keyboard buttons.

□ **BkL** : LCD Backlight continuously "ON" or switched-on Automatically on

operation of Keyboard buttons.



3. LOGIC BLOCKING OF FUNCTIONS

3.1 – Blocking Input

The time delayed tripping of any of the Protection functions, can be blocked by the activation of the Digital Input D1 (BI=Enable).

4. OUTPUT RELAYS

Four user programmable Output Relays are normally available R1, R2, R3, R4.

Each of them can be programmed to be controlled by any element (instantaneous or time delayed) of any of the Relay Functions.

Each output relay can also be programmed to operate "OPEN" and "CLOSE" control of the C/B either by the Relay Keyboard or via the serial communication bus

Moreover, the operation of each of the output relays can be programmed to be either Normally Deenergized (energized on tripping of the controlling Functional Element) or Normally Energized (Deenergized on tripping of the controlling Functional Element)

5. DIGITAL INPUTS

Three optoisolated, self-powered Digital Inputs D1, D2, D3 are provided. A Digital Input is activated when its terminals are shorted by a cold contact.

D1	(terminals 22 - 19) :	It is usable as Function Blocking Input
D2	(terminals 22 - 21) :	It is used for Remote Trip
D3	(terminals 22 - 20) :	The digital Input indicates the position of the Circuit Breaker (Input Closed = C/B closed; Input Open = C/B open).
		If the option External Trigger = Enabled any time the DI passed from closed to open the oscillographic recording is started.

6. SELFDIAGNOSTIC

The relay incorporates a sophisticated self-diagnostic feature that continuously checks the following elements:

A/D conversion

Checksum of the settings stored into E²Prom.

DSP general operation (Power, Routines, etc.)

Lamp test (only on manual test).

Any time Power is switched on, a complete test is run; then, during normal operation, the test runs continuously and the checksum is done any time a parameter is stored into E²Prom.

If during the test any Relay Internal Failure (I.R.F) is detected:

If "I.R.F." is programmed to "Trip", the programmed output relays are operated same as on tripping of any protection function operation is stored in the "Event Records" and the I.R.F. signal led is set to flashing.

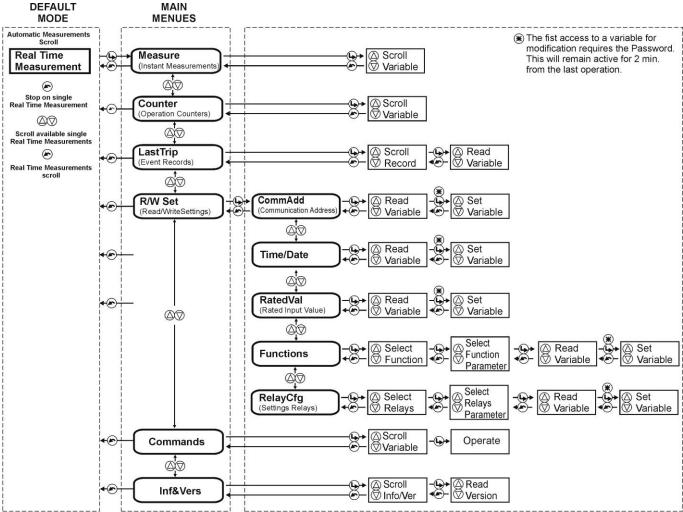
If "I.R.F." is programmed to "NO Trip", and only the I.R.F. signal led is set to flashing.



7. RELAY MANAGEMENT

The relay can be totally managed locally, either by the RS232 communication port or by the 4 key buttons and the LCD display, or remotely via the communication bus RS485 connected to the rear terminal blocks. The 2 line x 8 characters LCD display shows the available information. Key buttons operate according to the flow-chart herebelow.





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8. SIGNALIZATIONS

Four signal leds are available on the Front Face Panel:



a)	Green LED	C/B OPEN		Illuminated when C/B open status is detected. (Digital Input D3 Open)
b)	Red LED	C/B CLOSED	<u> </u>	Illuminated when C/B close status is detected. (Digital Input D3 closed) Flashing when Breaker Failure is detected.
c)	Red LED	TRIP (*)	<u> </u>	Flashing when a timed function starts to operate. Illuminated when any function is tripped; reset takes places by pressing the reset button.
d)	Yellow LED	PWR/ I.R.F.	_ _	Illuminated during normal operation when Power Supply is ON. Flashing when a Relay Internal Fault is detected.

(*) When any protection function is tripped besides the Led which gives the general trip indication. The display shows the function that caused the tripping:

LastTrip steady "Cause" blinking

9. KEYBOARD BUTTONS

ENTER	Enter	Give access to any menu or convalidate any programming changement. This button is besides used for the control of Open/Close C/B (see § Command).
RESET	Reset	Return from the actual selected menu to the former menu.
SELECT SELECT	Select +	Scrolls variables available in the different menus or increases/decreases setting values.
SELECT	Select -	



10. SERIAL COMMUNICATION PORT

10.1 . Main RS485 Serial Communication Port

This port is accessible via the terminals 1-2-3 provided on the relay terminal board.

It is used for connection to a serial bus interfacing up to 31 units with the Central Supervision System (SCADA, DCS, ecc).

The serial bus is a shielded pair of twisted cables connecting in parallel (Multi Drop) the different units (slaves) by the relevant terminals.

The physical link is RS485 and the Communication Protocol is MODBUS/RTU / IEC60870-5-103.

The configuration of transmission parameters is selectable.

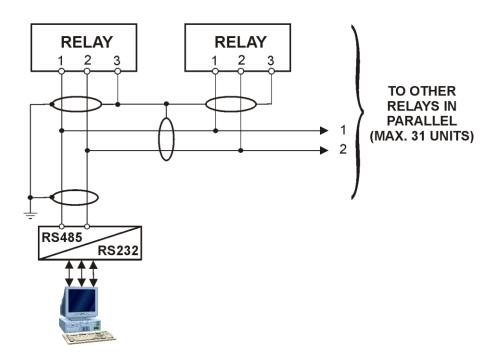
Baud Rate	:	9600/19200 bps	9600/19200 bps	9600/19200 bps
Start bit	:	1	1	1
Data bit	:	8	8	8
Parity	:	None	Odd	Even
Stop bit		1	1	1

Note: any change of this setting becomes valid at the next power on.

Each relay is identified by its programmable address code (NodeAd) and can be called from the P.C. A dedicated communication software (MSCom) for windows 95/98/NT4 SP3 (or later) is available. Please refer to the MSCom instruction manual for more information.

Maximum length of the serial bus can be up to 200m.

CONNECTION TO RS485



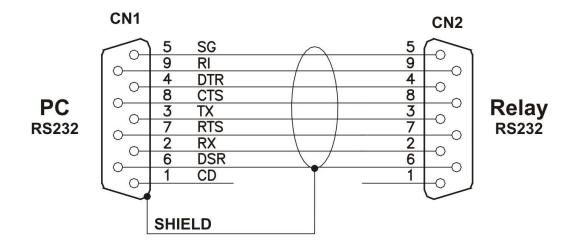
For longer distance and for connection of up to 250 Relays, optical interconnection is recommend. (please ask Microelettrica for accessories)

10.2 - Communication Port on Front Face Panel

This port is used for communication through the Front Face Panel between a local Lap-top PC.

The physical link is RS232 by the standard female 9-pin D-sub connector available on the Front Face Panel. Via this Port complete Relay management and data acquisition is possible.

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11. MENU AND VARIABLES

11.1 - Real Time Measurements

Scrolling display of the Real Time Measurements is the Default operation.

Scrolling can be stopped at any of the measurements and restarted by pressing the Reset button . When stopped on one variable, 🖲 appears aside the measurement and the different available measurements can be selected by the $\triangle \nabla$ buttons.

	Display		Description
I	= 0 - 65535	%ln	Line-Current (% of rated current)
٧	= 0 - 65535	٧	Line-Voltage
Χ	= 0 - 65535	ohm	Reactance
Tem	= 0 - 65535	%T	Actual temperature rise

11.2 - Meas (Instantaneous Measurements)

Real time measurements can be frozen at any moment selecting the menu "Instant Measure ":

" Real Time Meas "

" Meas "

" 1st Measurement

to go back to " Meas "



	Display		Description
I	= 0 - 65535	%ln	Line-Current (% of rated current)
٧	= 0 - 65535	٧	Line-Voltage
Х	= 0 - 65535	ohm	Reactance
Tem	= 0 - 65535	%Tn	Actual temperature rise

11.3 - Counter (Operation Counters)

to go back to "Counter "

The operation of any of the function herebelow reported, is counted and recorded in the menu "Counters ".

" Real Time Meas "

"Counter"

" 1st counters

	Displa	ау	Description
T>	=	0 - 65535	Number of Thermal Image
l>	=	0 – 65535	Number of 1 st Overcurrent (time delayed) trip
l>>	=	0 - 65535	Number of 2 nd Overcurrent (time delayed) trip
V>	=	0 - 65535	Number of 1 st Overvoltage (time delayed) trip
V>>	=	0 - 65535	Number of 2 nd Overvoltage (time delayed) trip
V<	=	0 - 65535	Number of 1 st Undervoltage (time delayed) trip
V<<	=	0 - 65535	Number of 2 nd Undervoltage (time delayed) trip
DI	=	0 - 65535	Number of operation of DI
Z<	=	0 - 65535	Number of operation of Z<
RTD	=	0 - 65535	Number of External Trip commands
I.R.F.	=	0 - 65535	Number of Internal Relay Faults
HR	=	0 - 65535	Number of HW recovery operations



11.4 - LastTrip (Event Recording)

The relay records any tripping and stores the information relevant to the last 20 tripping of protection functions (FIFO).

Each event recording includes the following information.

- " Real Time Meas "

-

"LastTrip "
1st event,

- $\triangle \nabla$ to scroll available events,

- to "Rec # " selected,

- △♥ to select the different fields;

		Display					Description			
Func xxxxx					Indication of the protection function which caused the relay tripping. For indication of the TRIP Cause the following acronyms are used:					
				-	l>	=	1 st Overcurrent (Short Circuit)			
				-	l>>	=	2 nd Overcurrent (Short Circuit)			
				-	V>	=	1 st Overvoltage			
				-	- $V>>$ = 2^{nd} Overvoltage					
				-	- V< = 1 st Undervoltage					
				-	2 nd Undervoltage					
				-	DI	=	Current step			
				-	Z<	=	Under-impedance			
				-	RTD	=	External Trip commands			
				-	- IRF = Internal Relay Fault					
Date	:	YYYY/MM/GG		Dat	e: Year/Mo	nth/Day				
Time	:	hh:mm:ss:cc		Tim	Time: hours/minutes/second/hundredths of seconds					
I	=	0 - 65535	%ln	Line	Line-Current (% of rated current)					
٧	=	0 - 65535	Vn	Line	Line-Voltage					
X	=	0 - 65535	ohm	Rea	Reactance					
Tem	=	0 - 65535	%Tn	Actu	ual tempera	ature rise				

- **t**o go back to "Rec # ",

- to go back to "Real Time Meas ".

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11.5 - R/W Set (Programming / Reading the Relay Settings)

" Main Menu "

△▽ select "Function "

 $\triangle \nabla$ select among following sub menus:

11.5.1 - CommAdd (Communication Address)

 $\triangle \bigcirc$ " Common " " Add: # "

" Password ???? "

 $\triangle \bigcirc \bigcirc$ to select the Address (1-250)

to validate. Set Done!

The default address is 1.

Display		Description	Setting Range	Step	Unit
Add:	1	Identification number for connection on serial communication bus	1 - 250	1	-

(if not yet entered; see § Password)

11.5.2 - Time/Date (Time/Date)

 $(\Delta)(\nabla)$ "Time/Date " Date: Current Date, Time: Current time

" YY/..... " $\triangle \bigcirc \bigcirc$ to set year, (L) " XX/MM " $\triangle \nabla$ to set month, (L) "XX/XX/DD" $\triangle \nabla$ to set day,

"XX/XX/XX" H " hh/mm " $\triangle \nabla$ to set hour, " XX/mm " $\triangle \nabla$ to set minutes, (L) (L) To validate Set Done!

Exit

11.5.3 - RatedVal (Rated Input Values)

1st Variable

 $\triangle \bigcirc$ to scroll variables to modify selected variable

" Password ???? " (if not yet entered) or #???

(if not yet entered; see § Password)

 $\triangle \bigcirc$ to set variable value,

to validate. Set Done!

	Display		Description	Settin	ıg R	ange	Step	Unit
I 1	1000	Α	Rated Primary current of phase C.T.	1	-	9999	1	Α
12	1	Α	Rated Secondary current of phase C.T.	1	-	5	1/5	Α
In	1000	Α	Reference primary current of the relay	1	-	9999	1	Α
V1	25	kV	Rated Primary voltage of phase V.T.	0.05	-	500	0.01	kV
V2	100	٧	Rated Secondary voltage of phase V.T.	50	-	115	0.01	V
Freq	60	Hz	System rated frequency	50	-	60	10	Hz
Tw	30	min	Warming-up time constant for Thermal Image	1	-	60	1	min.
lb	105	%ln	Maximum admissible continuous overload for Thermal Image	50	-	130	1	%ln



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11.5.4 - Function (Functions)

- △♥ "Function ",

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- 1st function,

- △♥ to scroll available Functions,

- to Read/Write setting of the selected function,

- △▽ to select the different definable fields - FuncEnab - TripLev - Options - Timers

to access the selected field and read the actual setting of the relevant variable

- to modify the actual setting;

- $\triangle \nabla$ to set the new value.

- 🕒 to validate. Set Done!

		Dis	splay					
Function	Туре		Variable	Default Setting	Unit	Description	Setting Range	Step
Password	•	=	0000-9999	1111	-	Password for programming enable (see § Password)		•
T>	FuncEnab	\rightarrow		Disa	able	Enable of the protection function	Enable/Disable	-
(F49)	Options	\rightarrow		NoPa	aram	No Parameters	-	-
	TripLev	\rightarrow	Tal	63	%Tb	Thermal prealarm	50 - 110	1
			Tst	50	%Tb	Reset level.	10 - 100	1
	Timers	\rightarrow		NoPa	aram	No Parameters	-	-
l>	FuncEnab	\rightarrow		Ena	able	Enable of the protection function	Enable/Disable	-
(1F51)	Options	\rightarrow	BI	Disa	able	Operation controlled by Blocking Digital Input	Enable/Disable	-
			Trg	Disa	able	Function operation triggers the oscillographic wave form capture	Enable/Disable	-
	TripLev	\rightarrow	l>	1.20	In	Trip level of overcurrent protection	0.50 - 20.00	0.01
	Timers	\rightarrow	tl>	1.00	s	Trip time delay	0.05 - 60.00	0.01
l>>	FuncEnab	\rightarrow		Ena	able	Enable of the protection function	Enable/Disable	-
(2F51)	Options	\rightarrow	BI	Disable		Operation controlled by Blocking Digital Input	Enable/Disable	-
			Trg	Disable		Function operation triggers the oscillographic wave form capture	Enable/Disable	-
	TripLev	\rightarrow	l>>	1.50 In		Trip level of overcurrent protection	0.50 - 40.00	0.01
	Timers	\rightarrow	tl>>	0.05	S	Trip time delay	0.05 - 60.00	0.01
V>	FuncEnab	\rightarrow		Ena	able	Enable of the protection function	Enable/Disable	-
(1F59)	Options	\rightarrow	BI	Disable Disable		Operation controlled by Blocking Digital Input	Enable/Disable	-
			Trg			Function operation triggers the oscillographic wave form capture	Enable/Disable	-
	TripLev	\rightarrow	V>	1.20	Vn	Trip level of overvoltage protection	0.50 - 1.50	0.01
	Timers	\rightarrow	tV>	1.00 s		Trip time delay	0.05 - 60.00	0.01
V>>	FuncEnab	\rightarrow		Ena	able	Enable of the protection function	Enable/Disable	-
(2F59)	Options	\rightarrow	BI	Disa	able	Operation controlled by Blocking Digital Input	Enable/Disable	-
			Trg	Disa	able	Function operation triggers the oscillographic wave form capture	Enable/Disable	-
	TripLev	\rightarrow	V>>	1.50	Vn	Trip level of overvoltage protection	0.50 - 1.50	0.01
	Timers	\rightarrow	tV>>	0.05 s		Trip time delay	0.05 - 60.00	0.01
V<	FuncEnab	\rightarrow		Disa	able	Enable of the protection function	Enable/Disable	-
(1F27)	Options	\rightarrow	BI	Disa	able	Operation controlled by Blocking Digital Input	Enable/Disable	-
			Trg Disable		able	Function operation triggers the oscillographic wave form capture	Enable/Disable	-
	TripLev	\rightarrow	V<	0.70	Vn	Trip level of undervoltage protection	0.20 - 1.20	0.01
ĺ	Timers	\rightarrow	tV<	1.00	S	Trip time delay	0.05 - 60.00	0.01



		Dis	splay					
Function	Туре		Variable	Default Value	Unit	Description	Setting Range	Step
'< <	FuncEnab	\rightarrow			able	Enable of the protection function	Enable/Disable	-
1F27)	Options	\rightarrow	BI	Disa	able	Operation controlled by Blocking Digital Input	Enable/Disable	-
			Trg	Disable		Function operation triggers the oscillographic wave form capture	Enable/Disable	-
	TripLev	\rightarrow		0.50	Vn	Trip level of undervoltage protection	0.20 - 1.20	0.01
	Timers	\rightarrow	tV<<	0.05	s	Trip time delay	0.05 - 60.00	0.01
DI	FuncEnab	\rightarrow		Ena	able	Enable of the protection function	Enable/Disable	-
	Options	\rightarrow			able	Operation controlled by Blocking Digital Input	Enable/Disable	-
			Trg	Disa	able	Function operation triggers the oscillographic wave form capture	Enable/Disable	-
			Ncy	1	су	Number of cycles for di/dt detection	1 - 4	1
			BX	Ena	able		Enable/Disable	-
	TripLev	\rightarrow	DI	10	%ln	Current step range	10 – 99.99	1
			di	10	A/ms	Minimum di/dt level to start ∆I evaluation and detection reset level	10 – 320	1
			X	50	ohm	Reactance setting range ≤.	5 – 50	1
	Time		2H	20	%ln	Second Harmonic Restraint	5 – 20	1
	Timers	\rightarrow	tDI	0.05	s s	Detection reset time delay Evaluation time	0.05 - 0.50 0.00 - 0.05	0.01
			tDI	0.10	S	Evaluation time	0.00 - 0.05	0.01
Z<	FuncEnab	\rightarrow		Disable		Enable of the protection function	Enable/Disable	-
	Options	\rightarrow	BI Trg	Bl Disable Trg Disable		Operation controlled by Blocking Digital Input Function operation triggers the oscillographic wave form capture	Enable/Disable Enable/Disable	-
	TripLev	+.	Z<	0.50	Zn	Trip level of under-impedance protection	0.10 – 1.00	0.01
	Timers	\rightarrow	tZ<	0.30	S	Trip time delay	0.05 - 60.00	0.01
		\rightarrow	LEN.					0.01
RTD	FuncEnab	\rightarrow		Disable		Enable of the protection function	Enable/Disable	-
	Options	\rightarrow		Parameters		<i>\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\</i>		
	TripLev Timers	\rightarrow		Parameters Parameters		<i>\{\}\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\</i>		
		\rightarrow	INU I			V	11/1/1//	///
IRF	FuncEnab	\rightarrow	0-1	Enable		Enable of the protection function	Enable/Disable	-
	Options	\rightarrow	Opl	NoTrip		Operation of output Relays on detection of Internal Relay Fault	NoTrip – Trip	
	TripLev Timers	\rightarrow		No Parameters No Parameters				///
	Timers	\rightarrow	INO I	arameters	,	<i>,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,</i>	1111111	
Osc	FuncEnab	\rightarrow		Ena	able	Enable of the protection function	Enable/Disable	-
	Options	\rightarrow	Trg		rip	Trigger operation mode	Disable, Start Trip, Ext.Inp	-
	TripLev	\rightarrow		Parameters				
	Timers	\rightarrow	tPre		30	Recording time before Trigger	0.10 - 0.50	0.1
		\rightarrow	tPost	0.	30	Recording time after Trigger	0.10 – 1.50	0.1
Comm	FuncEnab	\rightarrow	No F	Parameters	3	*//////////////////////////////////////		
	Options	\rightarrow			00	Local Baud Rate (Front panel RS232 communication speed)	9600 - 19200 38400 - 57600	-
			Rbd		200	Remote Baud Rate (Rear panel terminal blocks RS485 communication speed)	9600 - 19200	-
			Rmd	8,6	∋,1	Remote mode (communication parameters) Note: any change of this setting became valid at the next power on	8,n,1 8,o,1 8,e,1	-
			Rpr	IEC	103	Remote Protocol	IEC103-	_
						(For IEC870-5.103protocol set Rmd to 8,e,1)	Modbus	
	TripLev	\rightarrow				¥ <i>!!!!!!!!!!!!!!!!!!!!!!!</i>		W//
	Timers	\rightarrow	No Parameters		<u> </u>	<u> </u>	W./././/.	
LCD	FuncEnab	\rightarrow	No F	Parameters	3	<i>\////////////////////////////////////</i>		
LCD	Options	\rightarrow	Key BeepOFF		OFF	Buzzer "Beep" on operation of Keyboard buttons.	BeepON- BeepOFF	-
LCD								. —
LCD	·		BkL		ıto	LCD Backlight continuously "ON" or switched-on Automatically on operation of Keyboard buttons.	Auto-On	-
LCD	TripLev Timers	→	No F	Au Parameters	3		Auto-On	

Settings can also be programmed via the serial communication ports.

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11.6 - RelayCfg (Relay Configuration)

To associate one of the Output Relays to one or more functions (see § Password): enter the menu "R/W Set", select "Relay Cfg", select the "Relay #" to be programmed, select "Link"; at this stage the list of the available functions is displayed. Scrolling the list by the "+" and "-" keys the function is selected and than assigned by the key "Enter". The assignation is confirmed by the function indication that switches from blinking to steady.

Any of the Output Relays can be programmed to work in two different modes:

N.D. Normally Deenergized Relay is energized on trip of the associated functions
 N.E. Normally Energized Relay is deenergized on trip of the associated functions

Programming of working mode is made as above selecting "OpMode" istead of "Link".

	Dis	play				
Relay	Relay Type Default Descripti Value		Description	Setting Range	Step	
Relay1 (R1)	Link	\rightarrow	tl>, tl>>, tDl, tZ<	Association of functions to output relay R1	T> - Ta - I> - tl> - I>> - tl>> - V< - V< - V> - V>> - DI - tDI - Z< - tZ< - RTD - IRF - HwRec - CBopen - CBclose	-
	OpMode	\rightarrow	N.D.	N.D. (Normally Deenergized) N.E. (Normally Energized)	N.D./N.E.	-
Relay2 (R2)	Link	→ tV<, tV<<, tV>>		Association of functions to output relay R2	T> - Ta - I> - tl> - I>> - tl>> - V< - V< - V> - V> - DI - tDI – Z< - tZ< - RTD – IRF – HwRec – CBopen - CBclose	-
	OpMode	\rightarrow	N.D.	N.D. (Normally Deenergized) N.E. (Normally Energized)	N.D./N.E.	-
Relay3 (R3)	Link	\rightarrow	l>, l>>, V<, V<<, V>, V>>, DI, Z<	Association of functions to output relay R3	T> - Ta - I> - tl> - I>> - tl>> - V< - V< - V> - V> - DI - tDI - Z< - tZ< - RTD - IRF - HwRec - CBopen - CBclose	-
	OpMode	\rightarrow	N.D.	N.D. (Normally Deenergized) N.E. (Normally Energized)	N.D./N.E.	-
Relay4 (R4)	Link	nk → IRF		Association of functions to output relay R4	T> - Ta - I> - tI> - I>> - tI>> - V< - V< - V> - V>> - DI - tDI - Z< - tZ< - RTD - IRF - HwRec - CBopen - CBclose	-
	OpMode	\rightarrow	N.E.	N.D. (Normally Deenergized) N.E. (Normally Energized)	N.D./N.E.	-

11.7 - Commands

- 🕒 " Commands "
- 1st Control,
- $\triangle \bigcirc$ to select other available control,
- to operate selected control.

Dis	splay	Description
Clear	:	Erase memory of Trip Counters, Event Records.
Test	:	Starts a relay diagnostic test
Reset	:	Reset after trip
CBopen	:	Manual Open - Close Breaker
CBclose	:	Manual Close - Close Breaker

11.8 - Info&Ver (Firmware - Info&Version)

The menu displays the Relay Model and the Firmware Version

- "Real Time Meas "
- (Δ)(√) "Info/Ver ",

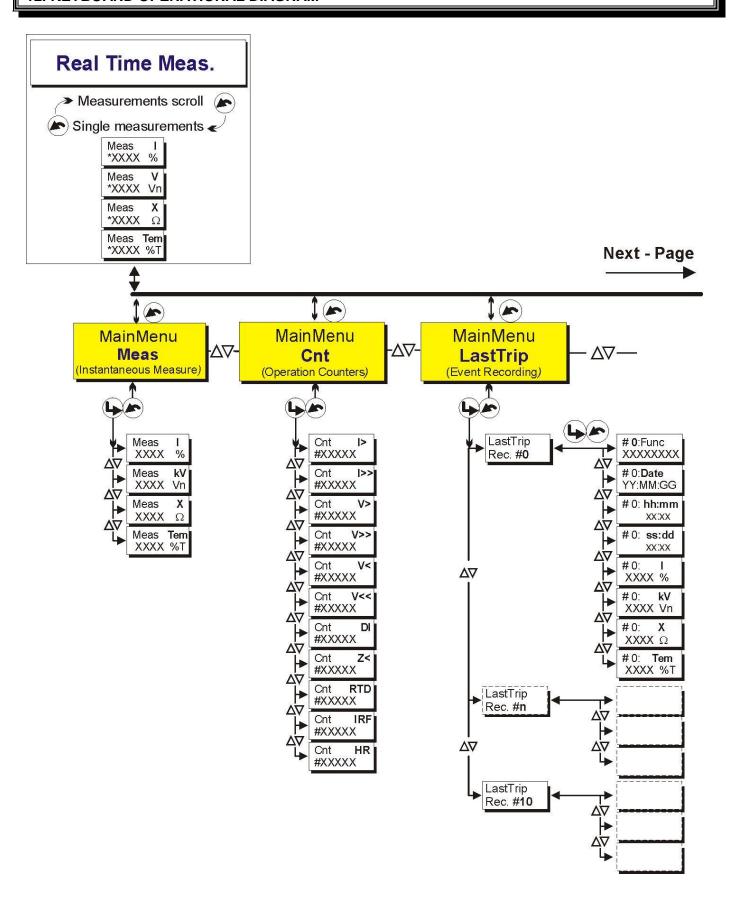
- △▽ " Model XXXXXX ", Model Relay
- △▽ " RelayVrs ###.#.#X", Firmware Version

- to go back to "Info&Ver ".
- to go back to "Real Time Meas "

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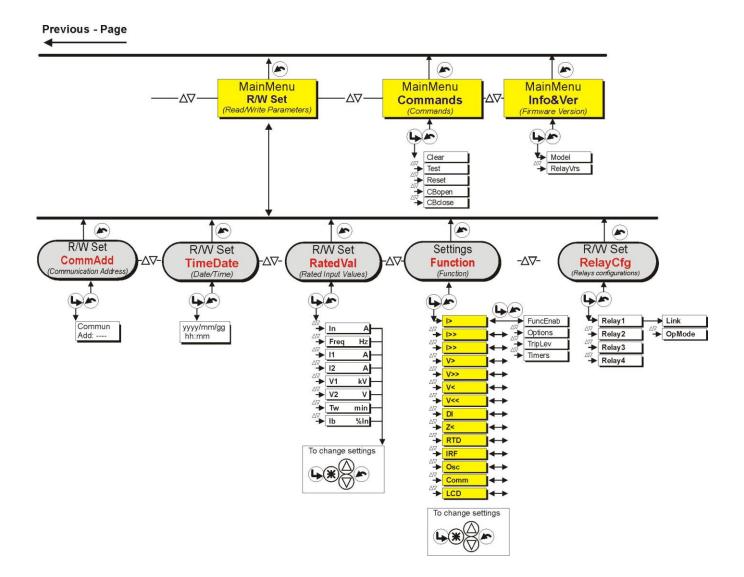


12. KEYBOARD OPERATIONAL DIAGRAM



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13. PASSWORD

This password is requested anytime the user wants to write in the "Settings" menu a command of the "Commands" menu.

MC11

The default password is "1111"

When password is required, proceed as follows

The Display shows the message "Password????" "

-	\triangle	to select 1 st digit (1-9)	(to validate
-	$\triangle \bigcirc$	to select 2 nd digit (1-9)	L	to validate
-	\bigcirc	to select 3 rd digit (1-9)	L	to validate
-	$(\Delta)(\nabla)$	to select 4 th digit (1-9)	(L)	to complete procedure.

The "password" is required any time you attempt to modify one of the programmable variables at the first entrance in the "Settings" and/or "Commands" menus.

The "password "remains valid for 2 minutes from the last operation of the programming buttons or until the button is pressed to return to the default display (RT Meas).

Once the Password has been entered, a "#" appears before the variable that can be modified.

13.1 - MS-Com Password

This password is requested anytime the user wants to send to the relay a setting parameters modification or to issue a command through the relay itself using the managing software MSCom. The user can decide whether inserting his own password (see MS-Com Operational Manual) or keeping the password disabled just clicking on the OK button when the password is requested.

14. MAINTENANCE

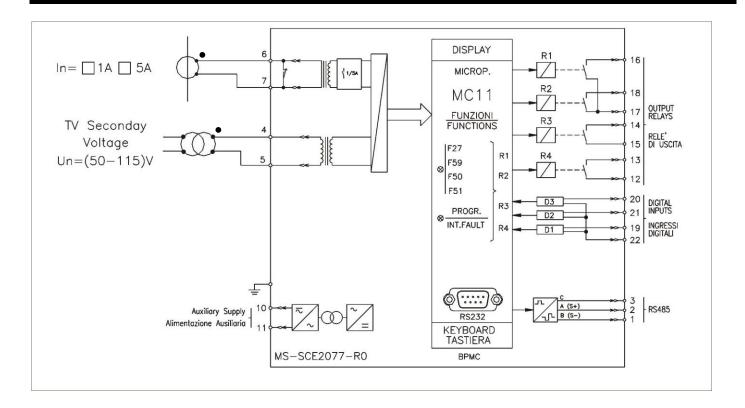
No maintenance is required. In case of malfunctioning please contact Microelettrica Scientifica Service or the local Authorised Dealer mentioning the relay's Serial No reported in the label on relays enclosure.

15. POWER FREQUENCY INSULATION TEST

Every relay individually undergoes a factory insulation test according to IEC255-5 standard at 2 kV, 50 Hz 1min. Insulation test should not be repeated as it unusefully stresses the dielectrics. When doing the insulation test, the terminals relevant to serial output, digital inputs and RTD input must always be short circuited to ground. When relays are mounted in switchboards or relay boards that have to undergo the insulation tests, the relay should be isolated. This is extremely important as discharges eventually tacking place in other parts or components of the board can severely damage the relays or cause damages not immediately evident to the electronic components.

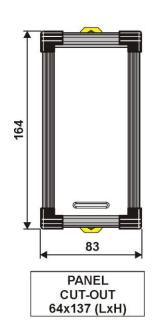


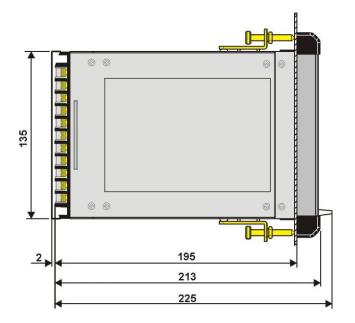
16. CONNECTION DIAGRAM



17. OVERALL DIMENSIONS

PROTECTION DEGREE IP44 (IP54 on request)





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18. DIRECTION FOR PCB'S DRAW-OUT AND PLUG-IN

18.1 - Draw-Out

Rotate clockwise the screws 1 in the horizontal position of the screws-driver mark. Draw-out the PCB by pulling on the handle 2

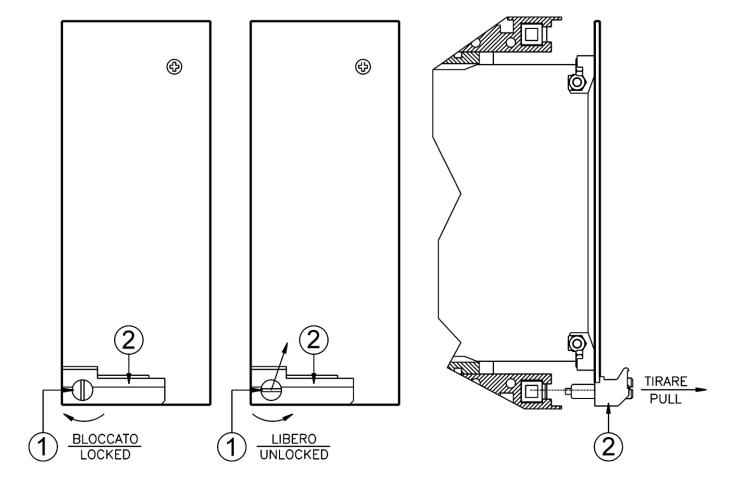
18.2 - Plug-In

Rotate clockwise the screws ① in the horizontal position of the screws-driver mark.

Slide-in the card on the rails provided inside the enclosure.

Plug-in the card completely and by pressing the handle to the closed position.

Rotate anticlockwise the screws ① with the mark in the vertical position (locked).



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19. ELECTRICAL CHARACTERISTICS

Dielectric test voltage IEC 60255-5 2kV, 50/60Hz, 1 min. Impulse test voltage IEC 60255-5 5kV (c.m.), 2kV (d.m.) − 1,2/50μs Insulation resistance >100MΩ Operation ambient temperature -10°C / +55°C Operation ambient temperature -25°C / +70°C Environmental testing (Cold) IEC660068-2-1 IEC661000-4-2 IEC660068-2-1 IEC661000-4-2 IEC660068-2-1 IEC661000-4-2 IEC661	AP	PROVAL: CE - REFEREN	ICE STANDARDS IEC	60255 - CE Direc	ctive - EN/	IEC61000 - IEEE C	<u> 37</u>
Insulation resistance		Dielectric test voltage		IEC 60255-5	2kV, 50/60	OHz, 1 min.	
Environmental Std. Ref. (IEC 60068)		Impulse test voltage		IEC 60255-5	5kV (c.m.)	, 2kV (d.m.) – 1,2/50)μs
Operation ambient temperature		Insulation resistance		> 100MΩ			
Storage temperature	En	vironmental Std. Ref. (IEC 6	<u>60068)</u>				_
Environmental testing		Operation ambient tempera	ture	-10°C / +55°C			
CDry heat)		Storage temperature		-25°C / +70°C			
Electromagnetic emission		Environmental testing	(Dry heat) (Change of temperature)	IEC60068-2-2 IEC60068-2-14	RH 93% V	Vithout Condensing	AT 40°C
Radiated electromagnetic field immunity test	CE	EMC Compatibility (EN610	00-6-2 - EN61000-6-4 - EN	N50263 <u>)</u>			_
ENV50204 900MHz/200Hz 10V/m Conducted disturbances immunity test IEC61000-4-6 level 3 0.15-80MHz 10V Electrostatic discharge test IEC61000-4-2 level 3 6kV contact / 8kV air Power frequency magnetic test IEC61000-4-8 1000A/m 50/60Hz Pulse magnetic field IEC61000-4-9 1000A/m 8/20µs Damped oscillatory magnetic field IEC61000-4-10 100A/m 0.1-1MHz Immunity to conducted common mode disturbance 0Hz-150KHz IEC61000-4-16 level 4 Immunity to conducted common mode disturbance test with damped oscillatory wave (1MHz burst test) IEC61000-4-16 level 3 2kV, 5kHz HF disturbance test with damped oscillatory wave (1MHz burst test) IEC60255-22-1 class 3 400pps, 2,5kV (m.c.), 1kV (d.m.) Oscillatory waves (Ring waves) IEC61000-4-12 level 4 4kV(c.m.), 2kV(d.m.) Surge immunity test IEC61000-4-12 level 4 4kV(c.m.), 1kV(d.m.) Voltage interruptions IEC60255-21-1 IEC60255-21-2 10-500Hz 1g ELECTRIC RATED VALUE		Electromagnetic emission		EN55011	industrial e	environment	
Electrostatic discharge test		Radiated electromagnetic fi	eld immunity test		level 3		
Power frequency magnetic test IEC61000-4-8 1000A/m 50/60Hz Pulse magnetic field IEC61000-4-9 1000A/m, 8/20µs Damped oscillatory magnetic field IEC61000-4-10 100A/m, 0.1-1MHz Immunity to conducted common mode disturbance OHz-150KHz Electrical fast transient/burst IEC61000-4-16 level 4 HF disturbance test with damped oscillatory wave (1MHz burst test) IEC60255-22-1 class 3 400pps, 2,5kV (m.c.), 1kV (d.m.) Oscillatory waves (Ring waves) IEC61000-4-12 level 4 4kV(c.m.), 2kV(d.m.) Surge immunity test IEC61000-4-5 level 4 2kV(c.m.), 1kV(d.m.) Voltage interruptions IEC60255-4-11 IEC60255-21-2 10-500Hz 1g Resistance to vibration and shocks IEC60255-21-1 - IEC60255-21-2 10-500Hz 1g ELECTRIC RATED VALUE Accuracy at reference value of influencing factors 2%		Conducted disturbances im-	munity test	IEC61000-4-6	level 3	0.15-80MHz	10V
Pulse magnetic field IEC61000-4-9 1000A/m, 8/20µs Damped oscillatory magnetic field IEC61000-4-10 100A/m, 0.1-1MHz Immunity to conducted common mode disturbance OHz-150KHz IEC61000-4-16 level 4 Electrical fast transient/burst IEC61000-4-4 level 3 2kV, 5kHz HF disturbance test with damped oscillatory wave (1MHz burst test) IEC60255-22-1 class 3 400pps, 2,5kV (m.c.), 1kV (d.m.) Oscillatory waves (Ring waves) IEC61000-4-12 level 4 4kV(c.m.), 2kV(d.m.) Surge immunity test IEC61000-4-5 level 4 2kV(c.m.), 1kV(d.m.) Voltage interruptions IEC60255-4-11 IEC60255-21-1 IEC60255-21-2 10-500Hz 1g ELECTRIC RATED VALUE 2% for measure 2% + to (to=20÷30ms @ 2xls) for times Accuracy at reference value of influencing factors 2% secondary mA/s Rated Current In = 1A/5A 400 A for 1 sec; 20A continuous Burden on current inputs Phase : 0.05VA at In = 1A ; 0.2VA at In = 5A Rated Voltage Un = (50 ÷115)V Voltage overload 2Un 1sec Burden on voltage inputs 0,2VA at Un ≤ 7 VA Output relays rating 6 A; Vn = 250 V A.C. resistive switching = 1500VA (400V max) make = 30 A (peak) 0,5 sec.; break = 0.3 A, 110 Vcc, Damped oscillatory magnetic IEC61000-4-10 IEC61000-4-16 level 4 IEC61000-4-16 level 4 IEC61000-4-16 level 4 IEC61000-4-10 IEC61000-4-12 Ievel 4 Ievel 3 IeC61000-4-12 Ievel 4 Ievel 4 Ievel 4 Ievel 4 Ievel 4 Ievel 4 Ievel 3 IeC61000-4-12 Ievel 4 Iev		Electrostatic discharge test		IEC61000-4-2	level 3	6kV contact / 8kV	air
Damped oscillatory magnetic field		Power frequency magnetic	test	IEC61000-4-8		1000A/m	50/60Hz
Immunity to conducted common mode disturbance 0Hz-150KHz		Pulse magnetic field		IEC61000-4-9		1000A/m, 8/20μs	
disturbance 0Hz-150KHz □ Electrical fast transient/burst		Damped oscillatory magneti	ic field	IEC61000-4-10		100A/m, 0.1-1MH	z
HF disturbance test with damped oscillatory wave (1MHz burst test)			mon mode	IEC61000-4-16	level 4		
(1MHz burst test) □ Oscillatory waves (Ring waves) □ Surge immunity test □ IEC61000-4-12 level 4 4kV(c.m.), 2kV(d.m.) □ Surge immunity test □ Resistance to vibration and shocks □ IEC60255-21-1 - IEC60255-21-2 10-500Hz 1g □ Accuracy at reference value of influencing factors □ Accuracy "di" □ Accuracy "di" □ 2 secondary mA/s □ Rated Current □ In = 1A/5A □ Current overload □ Burden on current inputs □ Phase : 0.05VA at In = 1A ; 0.2VA at In = 5A □ Rated Voltage □ Voltage overload □ Burden on voltage inputs □ Average power supply consumption ≤ 7 VA □ Output relays □ Output relays □ Acc. resistive switching = 1500VA (400V max) make = 30 A (peak) 0,5 sec.; break = 0.3 A, 110 Vcc,		Electrical fast transient/burs	t	IEC61000-4-4	level 3	2kV, 5kHz	
□ Surge immunity test □ Voltage interruptions □ Resistance to vibration and shocks □ ELECTRIC RATED VALUE □ Accuracy at reference value of influencing factors □ Accuracy "di" □ Accuracy "di" □ Accuracy "di" □ Accuracy "di" □ Layer to (to=20÷30ms @ 2xls) □ Accuracy "di" □ Layer to (to=20÷30ms @ 2xls) □ Accuracy "di" □ Layer to (to=20÷30ms @ 2xls) □ Layer to (to=20÷30ms & 2xls) □ Layer to (to=20÷30ms			mped oscillatory wave	IEC60255-22-1	class 3	400pps, 2,5kV (m	.c.), 1kV (d.m.)
□ Voltage interruptions IEC60255-4-11 □ Resistance to vibration and shocks IEC60255-21-1 - IEC60255-21-2 10-500Hz 1g ELECTRIC RATED VALUE 2% □ Accuracy at reference value of influencing factors 2% + to (to=20÷30ms @ 2xls) for times □ Accuracy "di" ± 2 secondary mA/s □ Rated Current In = 1A/5A □ Current overload 400 A for 1 sec; 20A continuous □ Burden on current inputs Phase : 0.05VA at In = 1A ; 0.2VA at In = 5A □ Rated Voltage Un = (50 ÷115)V □ Voltage overload 2Un 1 sec □ Burden on voltage inputs 0,2VA at Un □ Average power supply consumption ≤ 7 VA □ Output relays rating 6 A; Vn = 250 V A.C. resistive switching = 1500VA (400V max) make = 30 A (peak) 0,5 sec.; break = 0.3 A, 110 Vcc,		Oscillatory waves (Ring wav	ves)	IEC61000-4-12	level 4	4kV(c.m.), 2kV(d.	m.)
□ Resistance to vibration and shocks IEC60255-21-1 - IEC60255-21-2 10-500Hz 1g ELECTRIC RATED VALUE 2% for measure 2% + to (to=20÷30ms @ 2xls) for times □ Accuracy "di" ± 2 secondary mA/s □ Rated Current In = 1A/5A □ Current overload 400 A for 1 sec; 20A continuous □ Burden on current inputs Phase : 0.05VA at In = 1A ; 0.2VA at In = 5A □ Rated Voltage Un = (50 ÷115)V □ Voltage overload 2Un 1sec □ Burden on voltage inputs 0,2VA at Un □ Average power supply consumption ≤ 7 VA □ Output relays rating 6 A; Vn = 250 V A.C. resistive switching = 1500VA (400V max) make = 30 A (peak) 0,5 sec.; break = 0.3 A, 110 Vcc,		Surge immunity test		IEC61000-4-5	level 4	2kV(c.m.), 1kV(d.	m.)
ELECTRIC RATED VALUE □ Accuracy at reference value of influencing factors 2%		Voltage interruptions		IEC60255-4-11			
Accuracy at reference value of influencing factors $2\% + \text{to (to=}20 \div 30 \text{ms } @ 2 \text{xls})$ for measure $2\% + \text{to (to=}20 \div 30 \text{ms } @ 2 \text{xls})$ for times $2\% + \text{to (to=}20 \div 30 \text{ms } @ 2 \text{xls})$ for times $2\% + \text{to (to=}20 \div 30 \text{ms } @ 2 \text{xls})$ for times $2\% + \text{to (to=}20 \div 30 \text{ms } @ 2 \text{xls})$ for times $2\% + \text{to (to=}20 \div 30 \text{ms } @ 2 \text{xls})$ for times $2\% + \text{to (to=}20 \div 30 \text{ms } @ 2 \text{xls})$ for times $2\% + \text{to (to=}20 \div 30 \text{ms } @ 2 \text{xls})$ for times $2\% + \text{to (to=}20 \div 30 \text{ms } @ 2 \text{xls})$ for times $2\% + \text{to (to=}20 \div 30 \text{ms } @ 2 \text{xls})$ for times $2\% + \text{to (to=}20 \div 30 \text{ms } @ 2 \text{xls})$ for times $2\% + \text{to (to=}20 \div 30 \text{ms } @ 2 \text{xls})$ for times $2\% + \text{to (to=}20 \div 30 \text{ms } @ 2 \text{xls})$ for times $2\% + \text{to (to=}20 \div 30 \text{ms } @ 2 \text{xls})$ for times $2\% + \text{to (to=}20 \div 30 \text{ms } @ 2 \text{xls})$ for times $2\% + \text{to (to=}20 \div 30 \text{ms } @ 2 \text{xls})$ for times $2\% + \text{to (to=}20 \div 30 \text{ms } @ 2 \text{xls})$ for times $2\% + \text{to (to=}20 \div 30 \text{ms } @ 2 \text{xls})$ for times $2\% + \text{to (to=}20 \div 30 \text{ms } @ 2 \text{xls})$ for times $2\% + \text{to (to=}20 \div 30 \text{ms } @ 2 \text{xls})$ for times $2\% + \text{to (to=}20 \div 30 \text{ms } @ 2 \text{xls})$ for times $2\% + \text{to (to=}20 \div 30 \text{ms } @ 2 \text{xls})$ for times $2\% + \text{to (to=}20 \div 30 \text{ms } @ 2 \text{xls})$ for times $2\% + \text{to (to=}20 \div 30 \text{ms } @ 2 \text{xls})$ for times $2\% + \text{to (to=}20 \div 30 \text{ms } @ 2 \text{xls})$ for times $2\% + \text{to (to=}20 \div 30 \text{ms } @ 2 \text{xls})$ for times $2\% + \text{to (to=}20 \div 30 \text{ms } @ 2 \text{xls})$ for times $2\% + \text{to (to=}20 \div 30 \text{ms } @ 2 \text{xls})$ for times $2\% + \text{to (to=}20 \div 30 \text{ms } @ 2 \text{xls})$ for times $2\% + \text{to (to=}20 \div 30 \text{ms } @ 2 \text{xls})$ for times $2\% + \text{to (to=}20 \div 30 \text{ms } @ 2 \text{xls})$ for times $2\% + \text{to (to=}20 \div 30 \text{ms } @ 2 \text{xls})$ for times $2\% + \text{to (to=}20 \div 30 \text{ms } @ 2 \text{xls})$ for times $2\% + \text{to (to=}20 \div 30 \text{ms } @ 2 \text{xls})$ for times $2\% + \text{to (to=}20 \div 30 \text{ms } @ 2 \text{xls})$ for times $2\% + \text{to (to=}20 \div 30 \text{ms } @ 2 \text{xls})$ for times $2\% + \text{to (to=}20 \text{ms } @ 2 \text{ms } @ 2 \text{xls}$			shocks	IEC60255-21-1	- IEC6025	5-21-2 10-500Hz 1	9
 □ Rated Current □ Current overload □ Burden on current inputs □ Rated Voltage □ Voltage overload □ Burden on voltage inputs □ Average power supply consumption □ Average power supply consumption □ Output relays □ Output relays □ In = 1A/5A □ Hase: 0.05VA at In = 1A ; 0.2VA at In = 5A □ Un = (50 ÷115)V □ 2Un 1sec □ 0,2VA at Un □ Average power supply consumption □ Average power supply			e of influencing factors	* *	30ms @ 2xl		
 □ Current overload □ Burden on current inputs □ Rated Voltage □ Voltage overload □ Burden on voltage inputs □ Average power supply consumption □ Output relays □ Output relays □ Current overload □ Average power supply consumption □ Average power supply consumption □ Output relays □		Accuracy "di"		± 2 secondary m	nA/s		
 □ Burden on current inputs □ Rated Voltage □ Voltage overload □ Burden on voltage inputs □ Average power supply consumption □ Output relays □ Output relays □ Phase : 0.05VA at In = 1A ; 0.2VA at In = 5A □ Un = (50 ÷115)V □ QUn 1sec □ 0,2VA at Un □ 7 VA □ Output relays □ Average power supply consumption □ Average		Rated Current		In = 1A/5A			
 □ Rated Voltage □ Voltage overload □ Burden on voltage inputs □ Average power supply consumption □ Output relays <l< td=""><td></td><td>Current overload</td><td></td><td>400 A for 1 sec;</td><td>20A continu</td><td>ious</td><td></td></l<>		Current overload		400 A for 1 sec;	20A continu	ious	
 □ Voltage overload □ Burden on voltage inputs □ Average power supply consumption □ Output relays <l< td=""><td></td><td>Burden on current inputs</td><td></td><td>Phase : 0.05\</td><td>/A at In = 1/</td><td>; 0.2VA at In =</td><td>5A</td></l<>		Burden on current inputs		Phase : 0.05\	/A at In = 1/	; 0.2VA at In =	5A
 □ Burden on voltage inputs □ Average power supply consumption □ Output relays □ Output relays □ Average power supply consumption □ Output relays □ Output relays □ Average power supply consumption □ Av		Rated Voltage		Un = (50 ÷115)\	/		
 □ Average power supply consumption □ Output relays □ Acc. resistive switching = 1500VA (400V max) make = 30 A (peak) 0,5 sec.; break = 0.3 A, 110 Vcc, 		Voltage overload		2Un 1sec			
Output relays rating 6 A; Vn = 250 V A.C. resistive switching = 1500VA (400V max) make = 30 A (peak) 0,5 sec. ; break = 0.3 A, 110 Vcc,		Burden on voltage inputs		0,2VA at Un			
A.C. resistive switching = 1500VA (400V max) make = 30 A (peak) 0,5 sec.; break = 0.3 A, 110 Vcc,		Average power supply cons	sumption	≤ 7 VA			
L/R = 40 ms (100.000 op.) COMMUNICATION PARAMETER				A.C. resistive sw make = 30 A (pe	vitching = 15 eak) 0,5 sec) Vcc,

COMMUNICATION PARAMETER

RS485 (Back) 9600/19200 bps - 8,n,1 - 8,e,1 - 8,o,1 - Modbus RTU or IEC60870-5-103

9600/19200/38400/57600 - Modbus RTU RS232 (Front)

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